## **REMARKS**

Claims 1-17 were examined. Claims 1 and 10 are amended. Claims 1-17 remain in the Application.

The Patent Office rejects claims 1-17 under 35 U.S.C. §102(b) as anticipated by U.S. Patent No. 5,747,790 of Shimomura et al. (Shimomura).

Independent claim 1 is not anticipated by <u>Shimomura</u>, because <u>Shimomura</u> does not describe an apparatus comprising a plurality of devices formed on a substrate, a scribe line area separating each of the plurality of devices, and a masking material overlying a portion of the scribe line area, wherein process operations of material removal are completed and the apparatus is in a condition to be singulated. <u>Shimomura</u> teaches depositing a gap filler material in a scribe area of a substrate in which imaging devices are formed. <u>Shimomura</u>, however, teaches as a final processing operation to remove the gap filler material. <u>See</u> column 20, lines 58-63. Thus, the substrate in <u>Shimomura</u> requires at least one additional material removal operation. Further, in a process condition to be singulated, the apparatus of <u>Shimomura</u> does not include the gap filler layer from the scribe area.

Claims 2-9 depend from claim 1 and therefore contain all the limitations of that claim. For at least the reasons stated with respect to claim 1, claims 2-9 are not anticipated by Shimomura.

Independent claim 10 is not anticipated by <u>Shimomura</u>, because <u>Shimomura</u> does not describe a wafer comprising a plurality of integrated circuits not on a surface of a wafer adjacent a scribe line area and a masking material overlying a portion of a scribe line area, wherein process operations of material removal are completed and the apparatus is in a condition to be singulated. As noted above, <u>Shimomura</u> describes at least the removal of the gap filler layer from a scribe line area.

Claims 11-17 depend from claim 10 and therefore contain all the limitations of that claim. For at least the reasons stated with respect to claim 10, claims 11-17 are not anticipated by Shimomura.

Applicant respectfully requests the Patent Office withdraw the rejection of claims 1-17 under 35 U.S.C. §102(b).

## **CONCLUSION**

In view of the foregoing, it is believed that all claims now pending patentably define the subject invention over the prior art of record and are in condition for allowance and such action is earnestly solicited at the earliest possible date.

Respectfully submitted,

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I hereby certify that this correspondence is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Nedy Calderon

Date